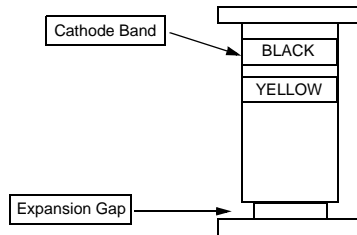


FDLL4151

Small Signal Diode

General Description

A general purpose diode that couples high forward conductance fast switching speed and high blocking voltages in a glass leadless LL-34 surface mount package. Placement of the expansion gap has no relationship to the location of the cathode terminal which is indicated by the first color band.



Absolute Maximum Ratings * $T_a = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Value	Units
V_{RRM}	Maximum Repetitive Reverse Voltage	75	V
$I_{F(AV)}$	Average Rectified Forward Current	200	mA
I_{FSM}	Non-repetitive Peak Forward Current Pulse Width = 1.0 second Pulse Width = 1.0microsecond	1.0	A
		4.0	A
T_{STG}	Storage Temperature Range	-65 to +200	$^\circ\text{C}$
T_J	Operating Junction Temperature	-65 to +200	$^\circ\text{C}$

* These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

NOTES:

1. These ratings are based on a maximum junction temperature of 200 degrees C.
2. These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

Thermal Characteristics

Symbol	Parameter	Value	Units
P_D	Power Dissipation	500	mW
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	350	$^\circ\text{C/W}$

Electrical Characteristics $T_C = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Conditions	Min.	Max	Units
V_R	Breakdown Voltage	$I_R = 5\mu\text{A}$	75		V
V_F	Forward Voltage	$I_F = 50\text{mA}$		1	V
I_R	Reverse Current	$V_R = 50\text{V}$		50	nA
		$V_R = 30\text{V}, T_A = 150^\circ\text{C}$		50	μA
C_T	Total Capacitance	$V_R = 0, f = 1.0\text{MHz}$		4	pF
t_{rr1}	Reverse Recovery Time	$I_F = I_R = 10\text{mA}, I_{RR} = 1\text{mA}$ $R_L = 100\Omega$		4	ns
t_{rr2}	Reverse Recovery Time	$V_R = 6\text{V}, I_F = 10\text{mA}, I_{RR} = 1\text{mA}$ $R_L = 100\Omega$		2	ns

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FACT Quiet Series™		OPTOLOGIC [®]	μSerDes™	UltraFET [®]
Across the board. Around the world.™		OPTOPLANAR™	SILENT SWITCHER [®]	UniFET™
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PRODUCT STATUS DEFINITIONS

Definition of Terms

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